

## 60V N-Channel Enhancement Mode MOSFET

### 1.Product Information

#### 1.1 Features

- ◇ Advanced SGT cell design
- ◇ Low Gate Charge
- ◇ Low On-Resistance
- ◇ RoHS and Halogen-Free Compliant
- ◇ 100%  $\Delta V_{DS}$  & UIS &  $R_g$  Tested

#### 1.2 Applications

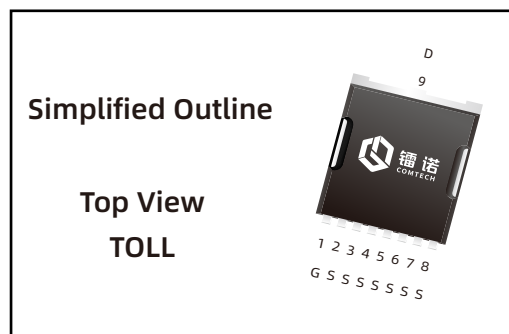
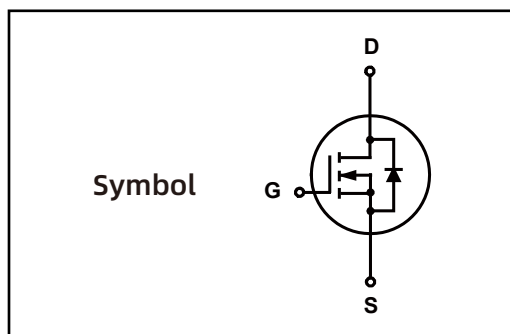
- ◇ DC-DC Converter
- ◇ Drones
- ◇ Motor drivers
- ◇ Light electric vehicles

#### 1.3 Quick reference

- ◇  $BV \cong 60\text{ V}$
- ◇  $P_{\text{tot}} \cong 441\text{ W}$
- ◇  $I_D \cong 355\text{ A}$
- ◇  $R_{DS(ON)} \cong 2.4\text{ m}\Omega @ V_{GS} = 10\text{ V}$
- ◇  $R_{DS(ON)} \cong 3.1\text{ m}\Omega @ V_{GS} = 6\text{ V}$



### 2.Pin Description



### 3.Limiting Values

| Symbol           | Parameter                      | Conditions                                                | Min | Max      | Unit               | Note   |
|------------------|--------------------------------|-----------------------------------------------------------|-----|----------|--------------------|--------|
| $V_{DS}$         | Drain-Source Voltage           | $T_C = 25\text{ }^{\circ}\text{C}$                        | -   | 60       | V                  | -      |
| $V_{GS}$         | Gate-Source Voltage            | $T_C = 25\text{ }^{\circ}\text{C}$                        | -   | $\pm 20$ | V                  | -      |
| $I_D^*$          | Drain Current ( DC )           | $T_C = 25\text{ }^{\circ}\text{C}, V_{GS} = 10\text{ V}$  | -   | 355      | A                  | Fig.2  |
|                  |                                | $T_C = 100\text{ }^{\circ}\text{C}, V_{GS} = 10\text{ V}$ | -   | 251      | A                  |        |
| $I_{DM}^{**/**}$ | Drain Current ( Pulsed )       | $T_C = 25\text{ }^{\circ}\text{C}, V_{GS} = 10\text{ V}$  | -   | 690      | A                  | -      |
| $P_{tot}$        | Drain power dissipation        | $T_C = 25\text{ }^{\circ}\text{C}$                        | -   | 441      | W                  | Fig.1  |
|                  |                                | $T_C = 100\text{ }^{\circ}\text{C}$                       | -   | 220      | W                  |        |
| $T_{stg}$        | Storage Temperature            |                                                           | -55 | 175      | $^{\circ}\text{C}$ | -      |
| $T_J$            | Junction Temperature           |                                                           | -   | 175      | $^{\circ}\text{C}$ | -      |
| $I_S$            | Continuous-Source Current      | $T_C = 25\text{ }^{\circ}\text{C}$                        | -   | 355      | A                  | -      |
| $E_{AS}^*$       | Single Pulsed Avalanche Energy | $V_{DD} = 60\text{ V}, L = 0.5\text{ mH}$                 | -   | 1089     | mJ                 | Fig.19 |

### 4.Thermal Characteristics

|                   |                                         |   |      |                      |        |
|-------------------|-----------------------------------------|---|------|----------------------|--------|
| $R_{\theta JA}^*$ | Thermal Resistance- Junction to Ambient | - | 25   | $^{\circ}\text{C/W}$ | Fig.16 |
| $R_{\theta JC}^*$ | Thermal Resistance- Junction to Case    | - | 0.34 |                      |        |

Notes :

\* Surface Mounted on 1 in<sup>2</sup> pad area,  $t \leq 10\text{ sec}$

\*\* Pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$

\*\*\* limited by bonding wire

### 5.Marking Information

| Product Name | Package | Reel size | Tape width | Quantity | Note |
|--------------|---------|-----------|------------|----------|------|
| LN020N060T-H | TOLL    | 330mm     | 24mm       | 2000     |      |

Note: COMTECH defines “ Green ” as lead-free ( RoHS compliant ) and halogen free ( Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C )

## 6. Electrical Characteristics ( $T_A=25^\circ$ Unless Otherwise Noted )

| Symbol                                   | Parameter                      | Conditions                                                                                                                  | Min | Typ   | Max  | Unit  | Note   |
|------------------------------------------|--------------------------------|-----------------------------------------------------------------------------------------------------------------------------|-----|-------|------|-------|--------|
| Static Characteristics                   |                                |                                                                                                                             |     |       |      |       |        |
| BV <sub>DSS</sub>                        | Drain-Source Breakdown Voltage | V <sub>GS</sub> = 0 V, I <sub>DS</sub> = 250 μA                                                                             | 60  | -     | -    | V     |        |
| V <sub>GS(th)</sub>                      | Gate Threshold Voltage         | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>DS</sub> = 250 μA                                                                | 2   | -     | 4    | V     |        |
| I <sub>DSS</sub>                         | Drain Leakage Current          | V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V                                                                               | -   | -     | 1    | μA    |        |
| I <sub>GSS</sub>                         | Gate Leakage Current           | V <sub>GS</sub> = ± 20 V, V <sub>DS</sub> = 0 V                                                                             | -   | -     | ±100 | nA    |        |
| R <sub>DS(ON)</sub> <sup>a</sup>         | On-State Resistance            | V <sub>GS</sub> = 10 V, I <sub>DS</sub> = 20 A                                                                              | -   | 2.1   | 2.4  | mΩ    | Fig.8  |
|                                          |                                | V <sub>GS</sub> = 6 V, I <sub>DS</sub> = 10 A                                                                               | -   | 2.7   | 3.1  |       |        |
| Diode Characteristics                    |                                |                                                                                                                             |     |       |      |       |        |
| V <sub>SD</sub> <sup>a</sup>             | Diode Forward Voltage          | I <sub>SD</sub> = 20 A, V <sub>GS</sub> = 0 V                                                                               | -   | -     | 1.3  | V     | Fig.7  |
| t <sub>rr</sub>                          | Reverse Recovery Time          | I <sub>DS</sub> = 20 A, V <sub>GS</sub> = 0 V<br>dI <sub>SD</sub> /dt = 100 A/μs                                            | -   | 50    | -    | nS    | Fig.20 |
| Q <sub>rr</sub>                          | Reverse Recovery Charge        |                                                                                                                             | -   | 65    | -    | nC    |        |
| Dynamic Characteristics <sup>b</sup>     |                                |                                                                                                                             |     |       |      |       |        |
| C <sub>iss</sub>                         | Input Capacitance              | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 30 V<br>Frequency = 1 MHz                                                          | -   | 4272  | -    | pF    | Fig.10 |
| C <sub>oss</sub>                         | Output Capacitance             |                                                                                                                             | -   | 1425  | -    |       |        |
| C <sub>rss</sub>                         | Reverse Transfer Capacitance   |                                                                                                                             | -   | 52    | -    |       |        |
| R <sub>G</sub>                           | Gate Resistance                | F= 1 MHz                                                                                                                    | -   | 1.8   | -    | Ω     |        |
| t <sub>d</sub> (on)                      | Turn-on Delay Time             | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 10 V,<br>R <sub>G</sub> =2.7 Ω, R <sub>L</sub> = 10 uH,<br>I <sub>DS</sub> = 20 A | -   | 28    | -    | nS    | Fig.18 |
| t <sub>r</sub>                           | Turn-on Rise Time              |                                                                                                                             | -   | 78    | -    |       |        |
| t <sub>d</sub> (off)                     | Turn-off Delay Time            |                                                                                                                             | -   | 50    | -    |       |        |
| t <sub>f</sub>                           | Turn-off Fall Time             |                                                                                                                             | -   | 24    | -    |       |        |
| dv/dt                                    | Peak Diode Recovery            |                                                                                                                             | -   | 0.306 | -    | KV/us |        |
| di/dt                                    | Peak Diode Recovery            |                                                                                                                             | -   | 441   | -    | A/us  |        |
| Gate Charge Characteristics <sup>b</sup> |                                |                                                                                                                             |     |       |      |       |        |
| Q <sub>g</sub>                           | Total Gate Charge              | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 10 V,<br>I <sub>DS</sub> = 20 A                                                   | -   | 64    | -    | nC    | Fig.9  |
| Q <sub>gs</sub>                          | Gate-Source Charge             |                                                                                                                             | -   | 15    | -    |       |        |
| Q <sub>gd</sub>                          | Gate-Drain Charge              |                                                                                                                             | -   | 24    | -    |       |        |
| V <sub>plateau</sub>                     | Gate plateau voltage           |                                                                                                                             | -   | 4.1   | -    | V     |        |

Notes :

a : Pulse test ; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ 

b : Guaranteed by design, not subject to production testing

## 7. Typical Characteristics

Fig.1 Power Capability

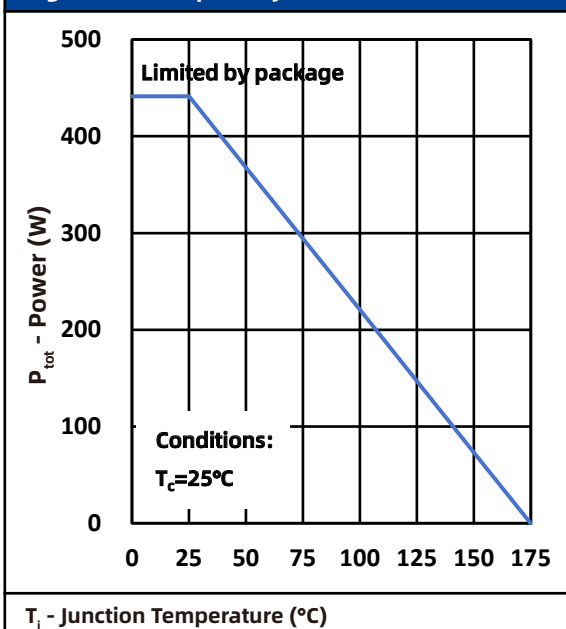


Fig.2 Current Capability

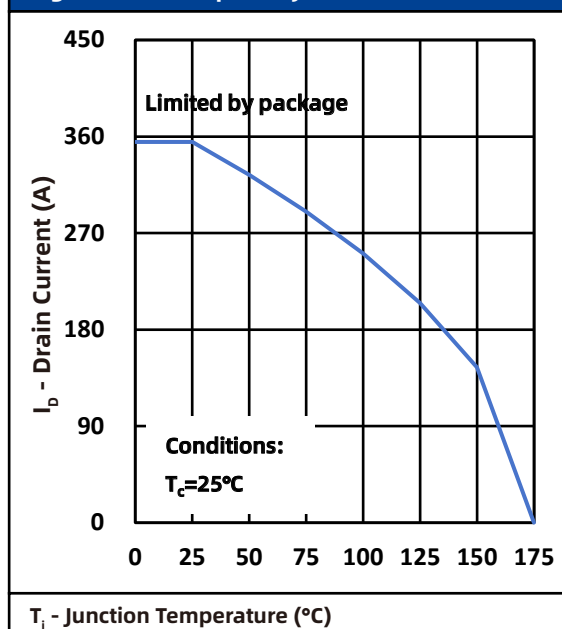


Fig.3 Output Characteristics@T<sub>j</sub> -55°C

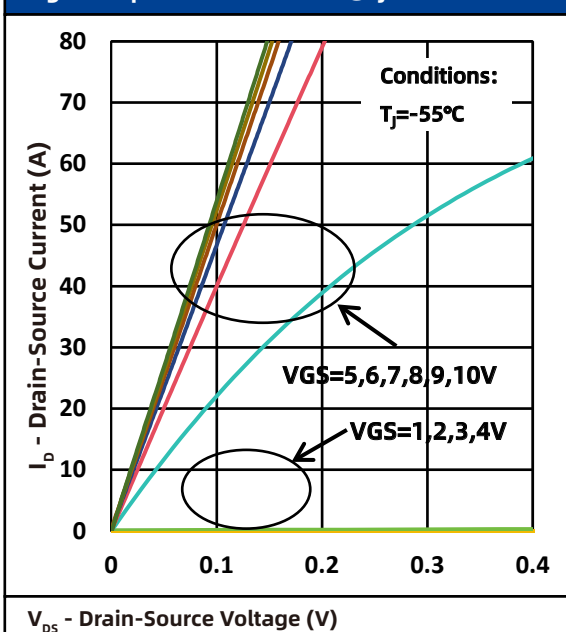
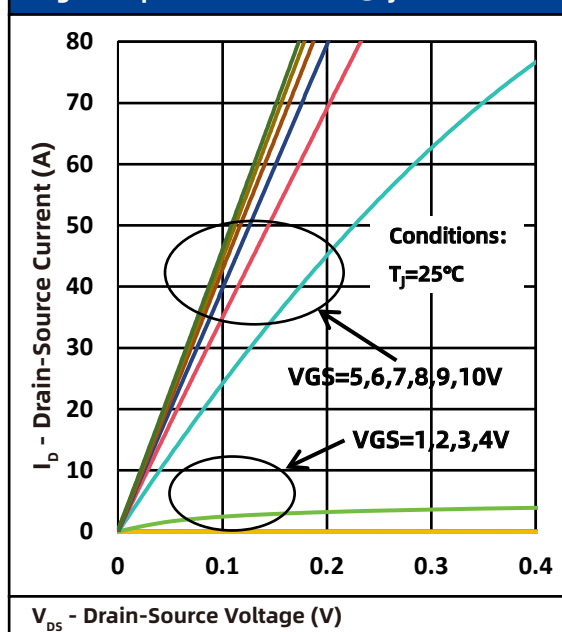


Fig.4 Output Characteristics@T<sub>j</sub> 25°C



## 7. Typical Characteristics

Fig.5 Output Characteristics@T<sub>j</sub> 175°C

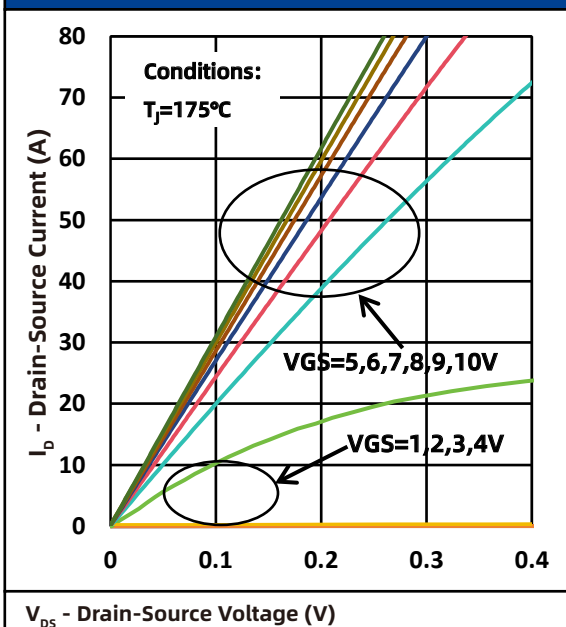


Fig.6 Transfer Characteristics vs Temp

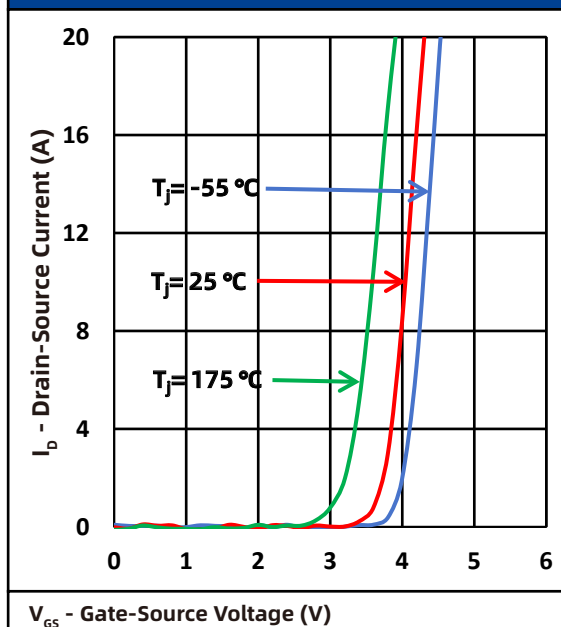


Fig.7 Body Diode Characteristics

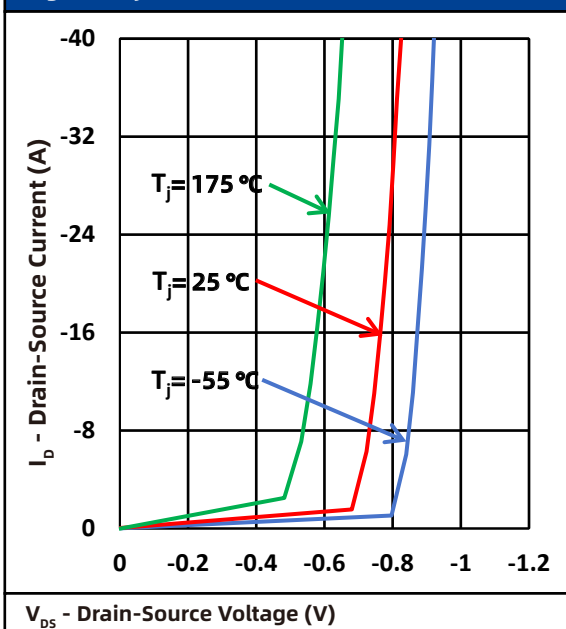
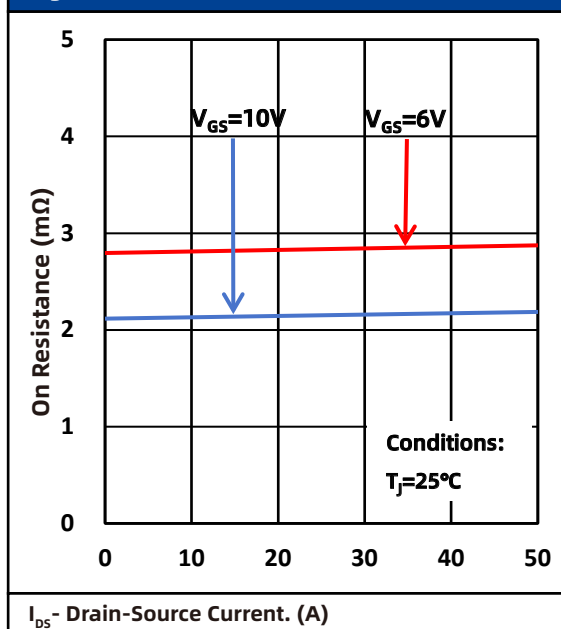


Fig.8 Drain-Source On Resistance



## 7. Typical Characteristics

Fig.9 Gate Charge

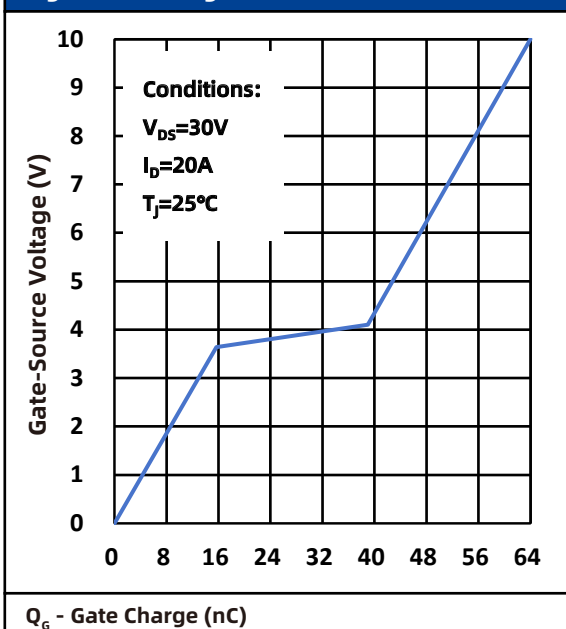


Fig.10 Capacitance

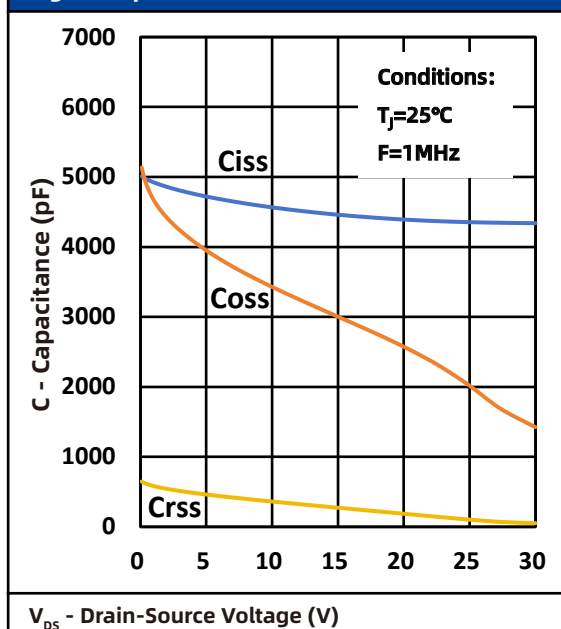


Fig.11 Normalized Threshold Voltage

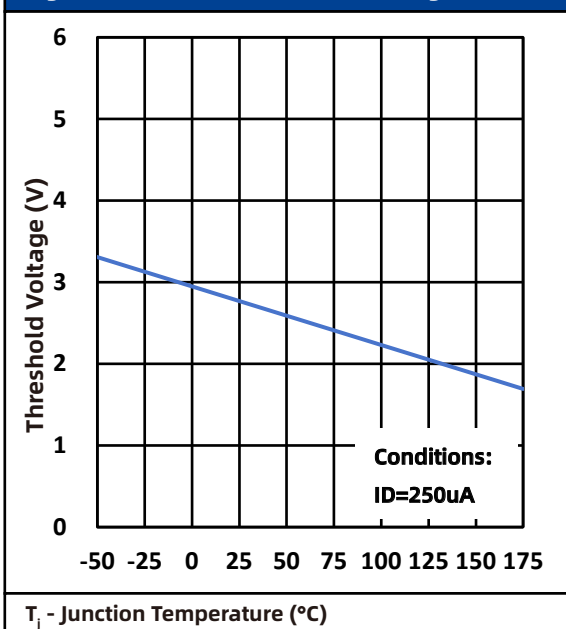
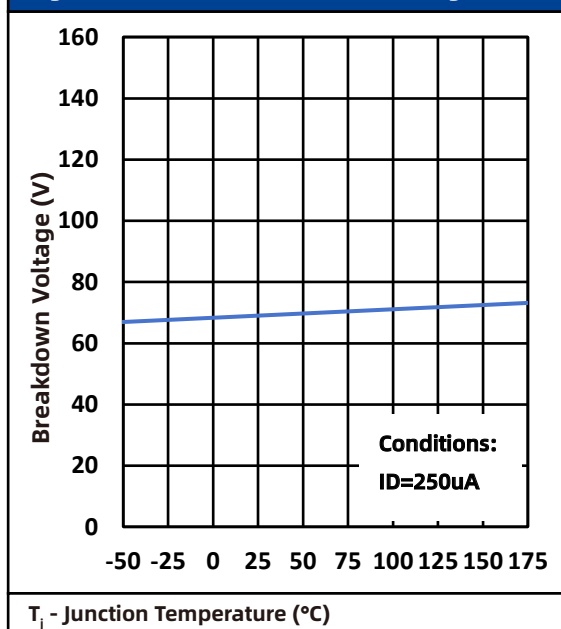


Fig.12 Normalized Breakdown Voltage



## 7. Typical Characteristics

Fig.13 Normalized On Resistance

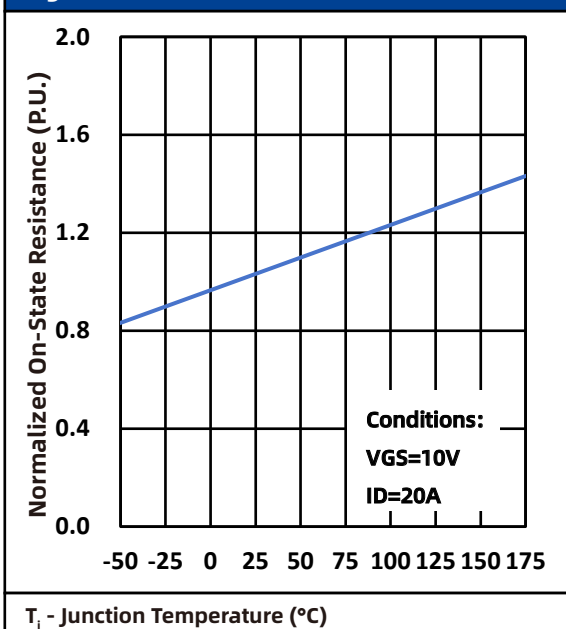
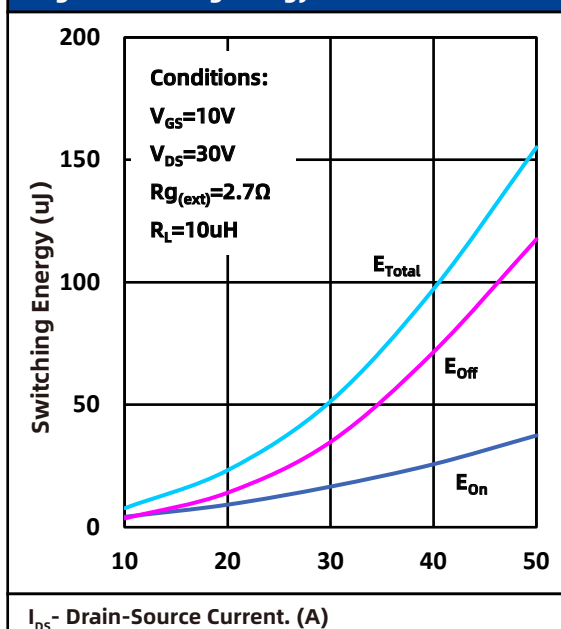
Fig.14 Switching Energy vs  $I_D$ 

Fig.15 Safe Operating Area

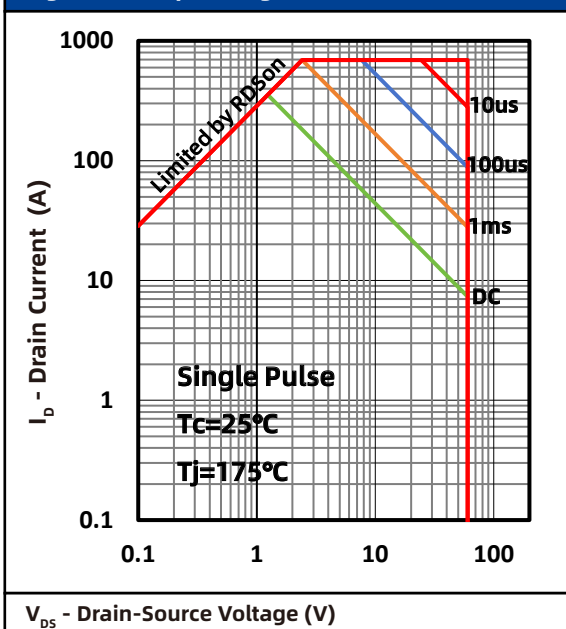
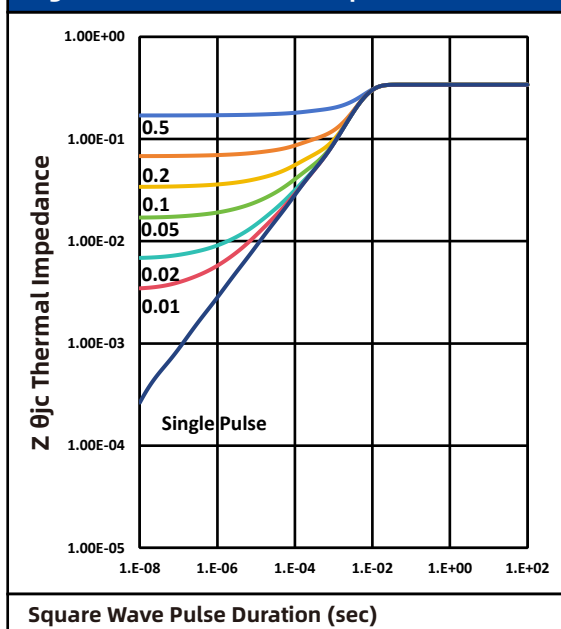


Fig.16 Transient Thermal Impedance



## 7. Typical Characteristics

Fig.17 Gate Charge Test Circuit & Waveform

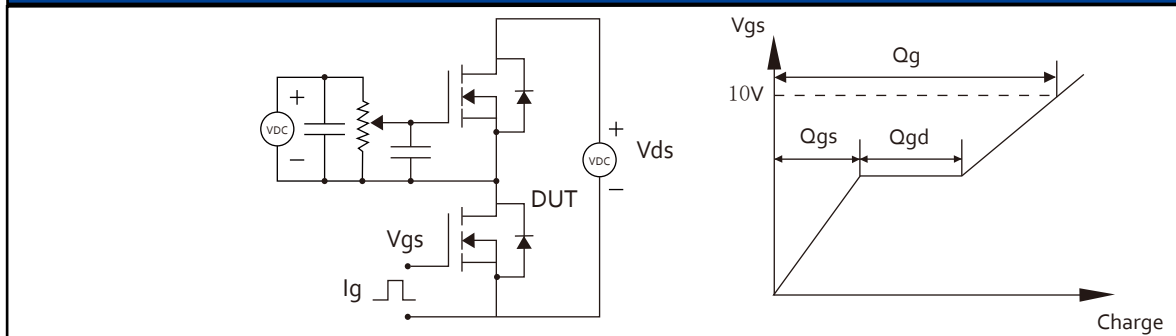


Fig.18 Resistive Switching Test Circuit & Waveforms

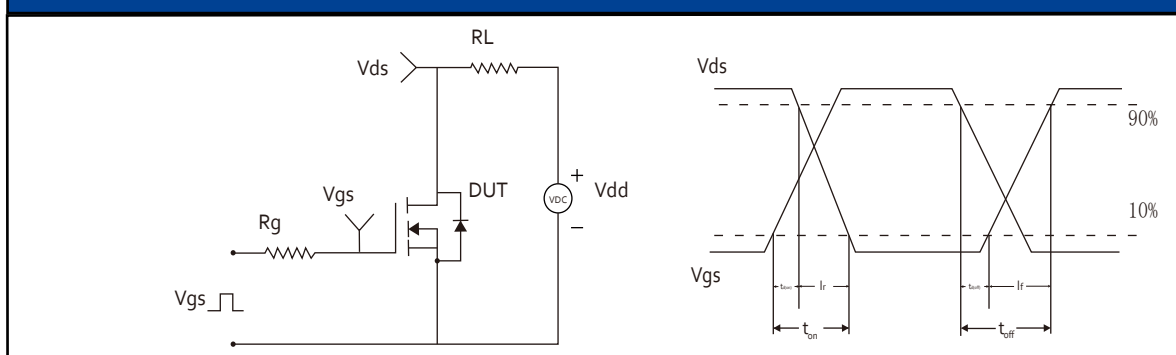


Fig.19 Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

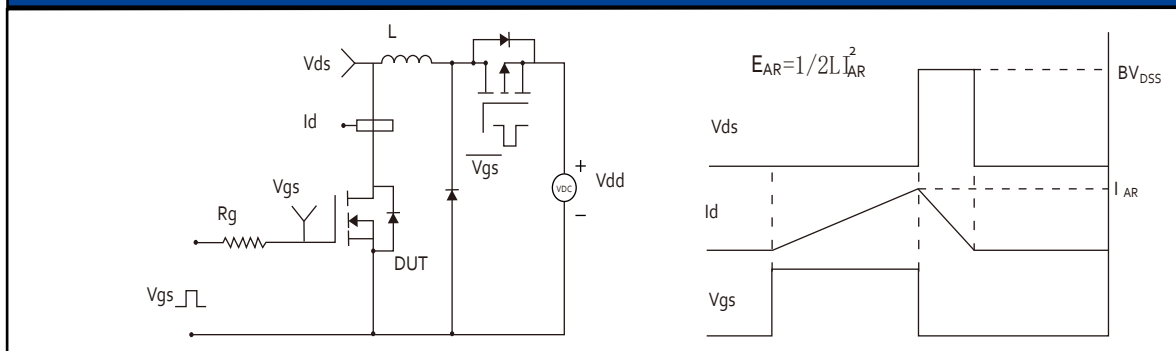
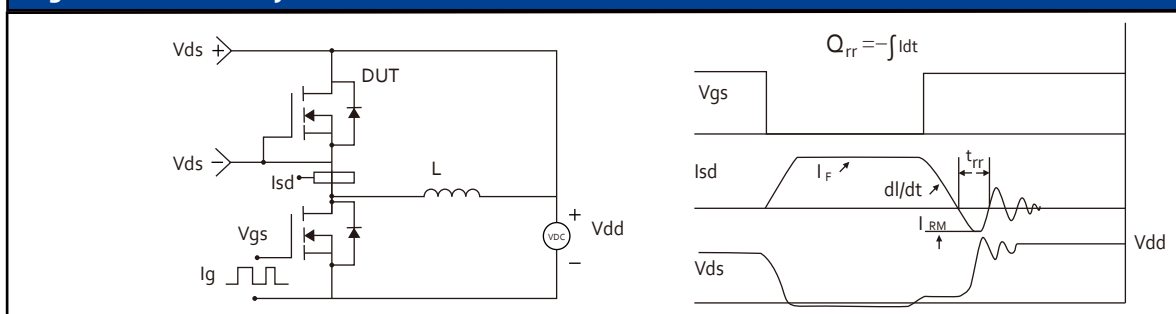
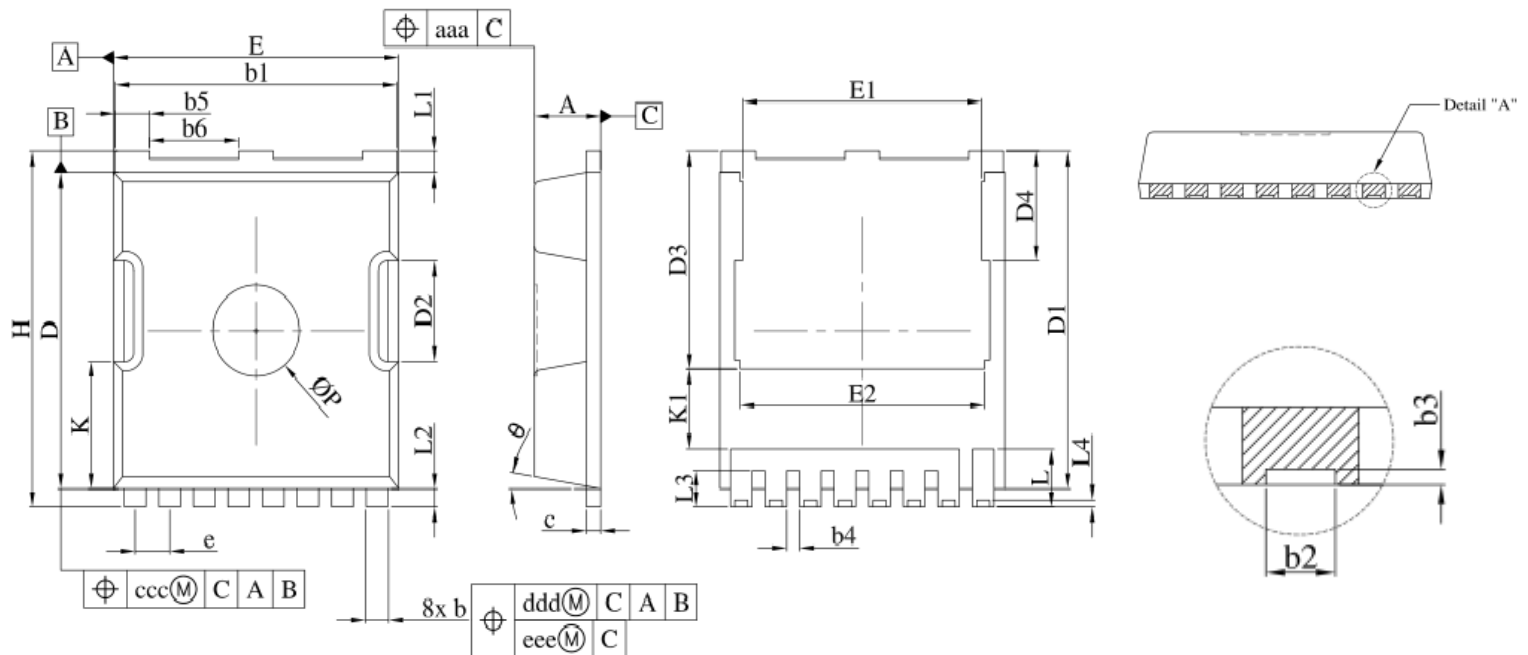


Fig.20 Diode Recovery Test Circuit & Waveforms



## 8. Package Dimensions

### TOLL Package



| Symbol   | Dimensions In Millimeters |       |       |
|----------|---------------------------|-------|-------|
|          | MIN.                      | NOM.  | MAX.  |
| A        | 2.20                      | 2.30  | 2.40  |
| b        | 0.70                      | 0.80  | 0.90  |
| b1       | 9.70                      | 9.80  | 9.90  |
| b2       | 0.36                      | 0.45  | 0.55  |
| b3       | 0.05                      | 0.10  | 0.35  |
| b4       | 0.30                      | 0.40  | 0.50  |
| b5       | 1.10                      | 1.20  | 1.30  |
| b6       | 3.00                      | 3.10  | 3.20  |
| c        | 0.40                      | 0.50  | 0.60  |
| D        | 10.28                     | 10.38 | 10.55 |
| D1       | 10.98                     | 11.08 | 11.18 |
| D2       | 3.20                      | 3.30  | 3.40  |
| D3       | 7.00                      | 7.15  | 7.30  |
| D4       | 3.44                      | 3.59  | 3.74  |
| e        | 1.10                      | 1.20  | 1.30  |
| E        | 9.80                      | 9.90  | 10.00 |
| E1       | 8.20                      | 8.30  | 8.40  |
| E2       | 8.35                      | 8.50  | 8.65  |
| H        | 11.50                     | 11.68 | 11.85 |
| K        | 4.08                      | 4.18  | 4.28  |
| K1       | 2.45                      | -     | -     |
| L        | 1.60                      | 1.90  | 2.10  |
| L1       | 0.50                      | 0.70  | 0.90  |
| L2       | 0.50                      | 0.60  | 0.70  |
| L3       | 1.00                      | 1.20  | 1.30  |
| L4       | 0.13                      | 0.23  | 0.33  |
| P        | 2.85                      | 3.00  | 3.15  |
| $\theta$ | 10°REF.                   |       |       |
| aaa      | 0.20                      |       |       |
| ccc      | 0.20                      |       |       |
| ddd      | 0.25                      |       |       |
| eee      | 0.20                      |       |       |



## 9. Record of Document amendment

产品名称：LN020N060T-H

文档类型：产品手册

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公司主页：[www.leinuosemi.com](http://www.leinuosemi.com)

版本：01

修改记录：

1.初版发行